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IN THE UNITED STATES PATENT

In re application of :
Tadashi MAEDA et al. : **Mail Stop: PCT**
Serial No. NEW : Attorney Docket No. 2006_1151A
Filed July 20, 2006 :

FLUX FOR SOLDERING AND
SOLDERING PROCESS
[Corresponding to PCT/JP2005/001087
Filed January 27, 2005]

PRELIMINARY AMENDMENT

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

In the interest of compact prosecution, please amend the present application as follows:

ATTACHMENT D